

**10-FY12B2A032ME-L387L28**

datasheet

Vincotech

flowBOOST 1 dual SiC**1200 V / 32 mΩ****Topology features**

- Kelvin Emitter for improved switching performance
- Dual Booster
- Bypass Diode
- Integrated DC capacitor
- Temperature sensor

Component features

- High Blocking Voltage with low drain source on state resistance
- High speed SiC-MOSFET technology
- Resistant to Latch-up

Housing features

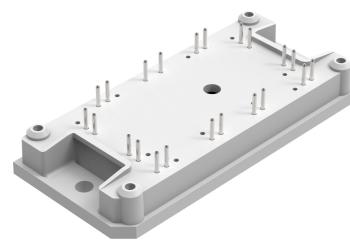
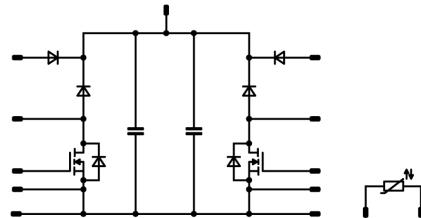
- Base isolation: Al₂O₃
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Solder pin

Target applications

- Energy Storage Systems
- Solar Inverters

Types

- 10-FY12B2A032ME-L387L28

flow 1 12 mm housing**Schematic**



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Switch				
Drain-source voltage	V_{DSS}		1200	V
Drain current (DC current)	I_D	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	38	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	120	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	70	W
Gate-source voltage	V_{GSS}		-4 / 15	V
		dynamic	-8 / 19	
Maximum Junction Temperature	T_{jmax}		175	°C

Boost Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	36	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	104	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 25^\circ\text{C}$	184	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	107	W
Maximum junction temperature	T_{jmax}		175	°C

Boost Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	44	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 150^\circ\text{C}$	270	A
Surge current capability	I^t		370	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	51	W
Maximum junction temperature	T_{jmax}		150	°C



10-FY12B2A032ME-L387L28

datasheet

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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
ByPass Diode				
Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	44	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$	270	A
Surge current capability	P_t	$T_j = 150^\circ\text{C}$	370	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	51	W
Maximum junction temperature	T_{jmax}		150	$^\circ\text{C}$

Capacitor (DC)

Maximum DC voltage	V_{MAX}		1000	V
Operation Temperature	T_{op}		-55 ... 125	$^\circ\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				>12,7	mm
Clearance				9,6	mm
Comparative Tracking Index	CTI			≥ 200	

*100 % tested in production



10-FY12B2A032ME-L387L28

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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Boost Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		15		40	25 125 150	22,4	31,2 41,5 46,3	41,6 ⁽¹⁾	mΩ
Gate-source threshold voltage	$V_{GS(th)}$		0		0,0115	25	1,8	2,5	3,6	V
Gate to Source Leakage Current	I_{GSS}		15	0		25		10	250	nA
Zero Gate Voltage Drain Current	I_{DSS}		0	1200		25		1	19	µA
Internal gate resistance	r_g							1,7		Ω
Gate charge	Q_g		-4/15	800	40	25		118		nC
Short-circuit input capacitance	C_{iss}	$f = 100$ kHz	0	1000	0	25		3357		pF
Short-circuit output capacitance	C_{oss}							129		
Reverse transfer capacitance	C_{rss}							8		
Diode forward voltage	V_{SD}		0		20	25		4,6		V

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,36		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/15	700	32	25 125 150		18,15 16,19 16,01		ns
Rise time	t_r					25 125 150		6,58 6,03 6,01		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		47,16 53,66 55,43		ns
Fall time	t_f	$Q_{fFWD}=0,123 \mu C$ $Q_{fFWD}=0,115 \mu C$ $Q_{fFWD}=0,115 \mu C$				25 125 150		14,33 14,38 13,91		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		0,254 0,218 0,212		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,15 0,161 0,163		mWs



10-FY12B2A032ME-L387L28

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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Diode

Static

Forward voltage	V_F				20	25 125		1,46 1,8	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25		80	600	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,89		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=6028$ A/µs $di/dt=6886$ A/µs $di/dt=6726$ A/µs	0/15	700	32	25		30,46		A
Reverse recovery time	t_{rr}					125		34,74		
Recovered charge	Q_r					150		35,01		
Recovered charge	Q_r		0/15	700	32	25		10,03		ns
Reverse recovered energy	E_{rec}					125		10,09		
Reverse recovered energy	E_{rec}					150		10,08		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		0,123		μ C
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		0,115		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		0,115		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		0,019		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		0,017		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		0,018		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		7545,18		A/µs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		9847,67		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		10227,23		



10-FY12B2A032ME-L387L28

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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	

Boost Sw. Protection Diode

Static

Forward voltage	V_F				28	25 125 150		1,1 1,04 1,03	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,37		K/W
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ByPass Diode

Static

Forward voltage	V_F				28	25 125 150		1,1 1,04 1,03	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,37		K/W
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Capacitor (DC)

Static

Capacitance	C	DC bias voltage = 0 V				25		47		nF
Tolerance							-10		10	%
Dissipation factor		$f = 1$ kHz				25		2,5		%



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datasheet

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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

(¹) Value at chip level

(²) Only valid with pre-applied Vincotech thermal interface material.



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Boost Switch Characteristics

figure 1. MOSFET

Typical output characteristics
 $I_D = f(V_{DS})$

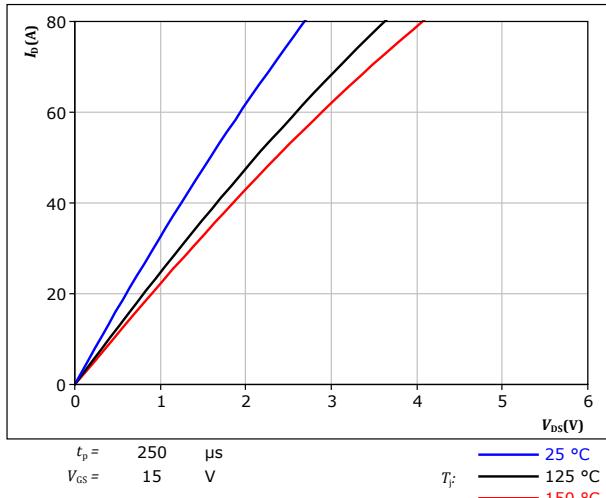


figure 3. MOSFET

Typical transfer characteristics
 $I_D = f(V_{GS})$

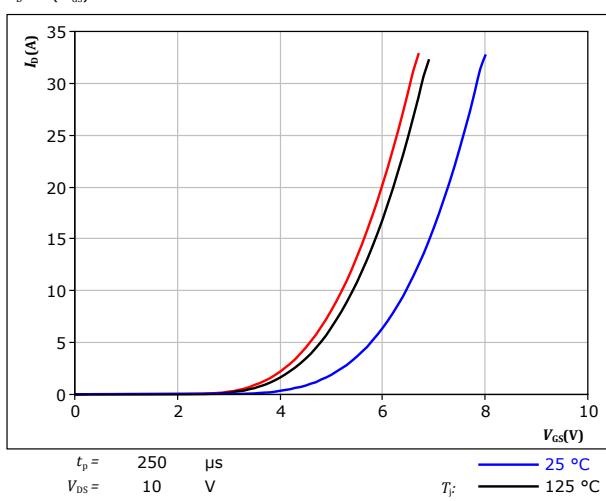


figure 2. MOSFET

Typical output characteristics
 $I_D = f(V_{DS})$

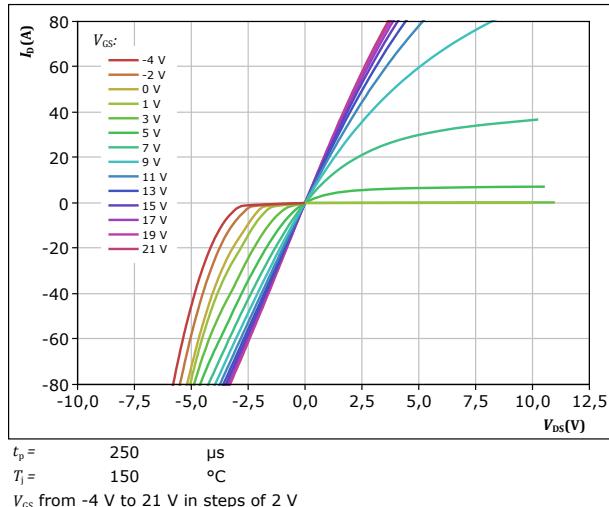
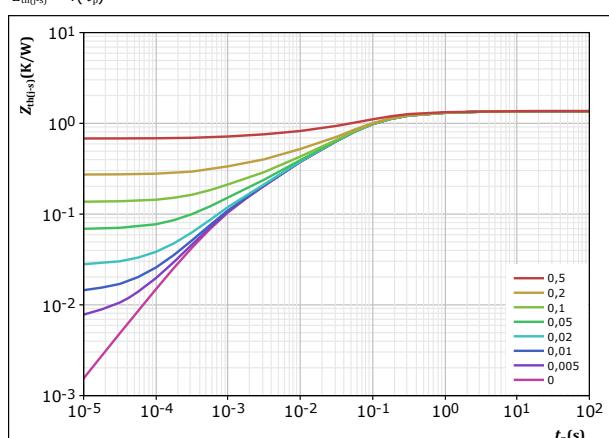


figure 4. MOSFET

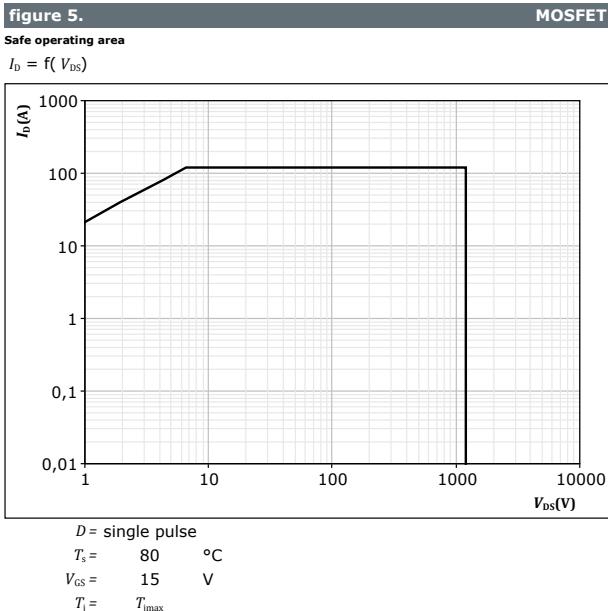
Transient thermal impedance as a function of pulse width
 $Z_{th(t-s)} = f(t_p)$



R (K/W)	τ (s)
7,53E-02	2,27E+00
2,27E-01	2,80E-01
7,32E-01	6,31E-02
2,40E-01	7,73E-03
8,78E-02	7,83E-04

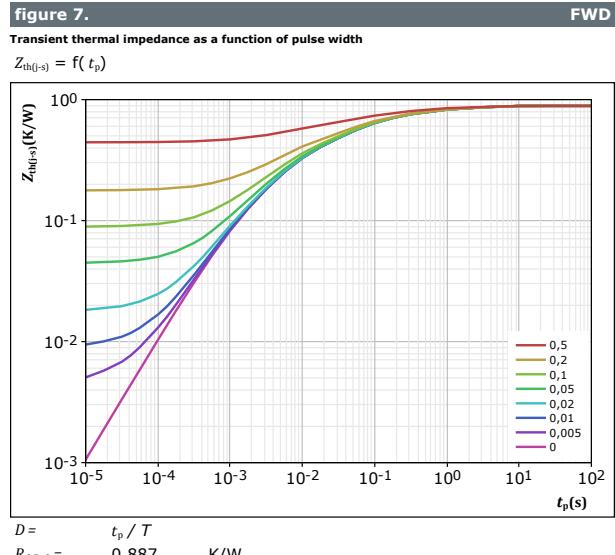
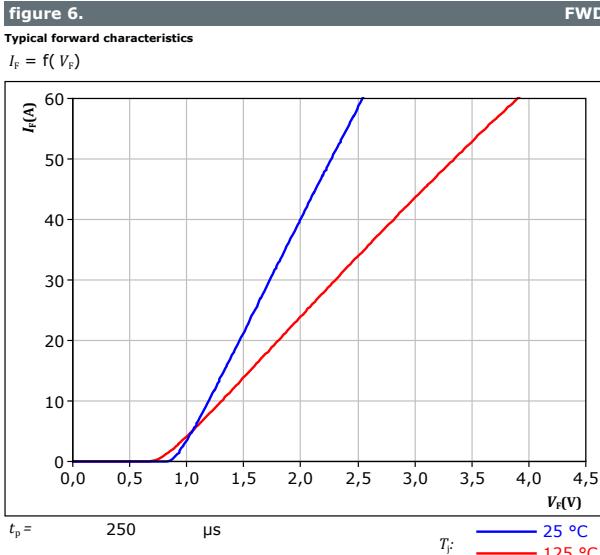


Boost Switch Characteristics



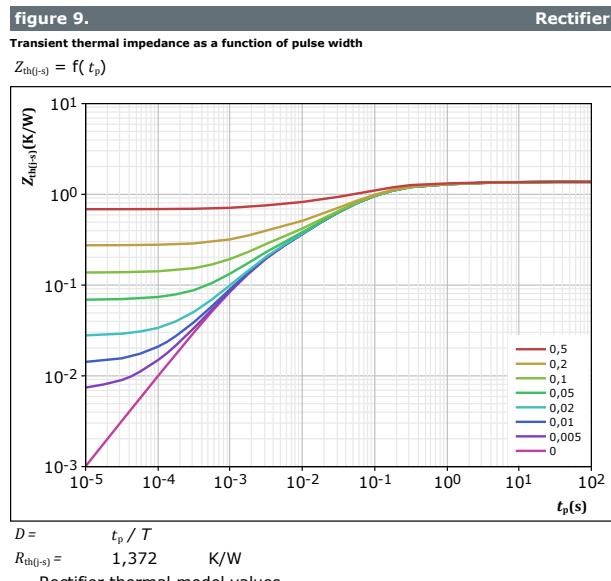
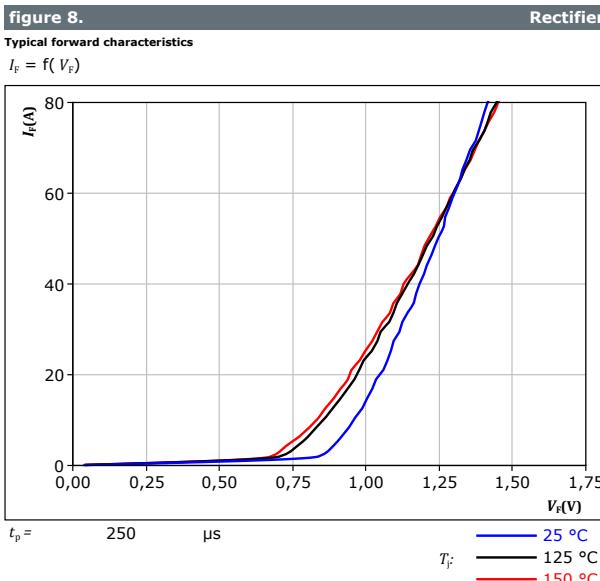


Boost Diode Characteristics





Boost Sw. Protection Diode Characteristics





ByPass Diode Characteristics

figure 10.

Typical forward characteristics

$$I_F = f(V_F)$$

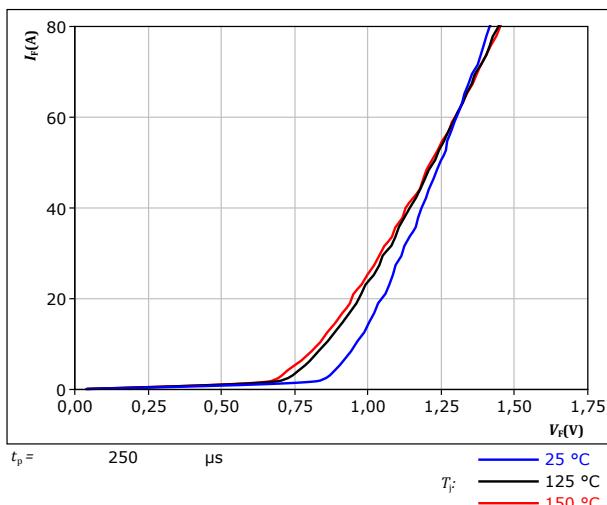
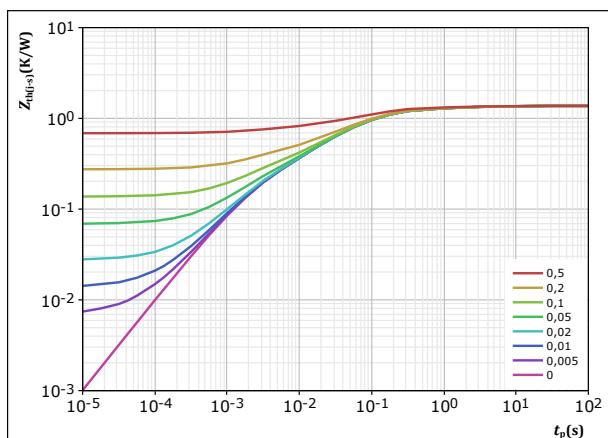


figure 11.

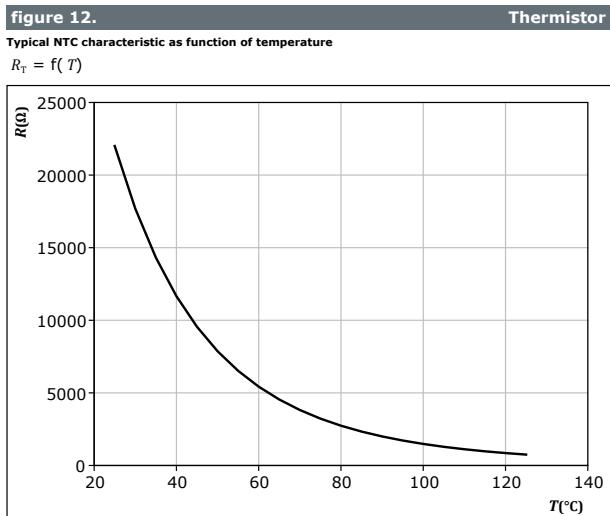
Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





Thermistor Characteristics





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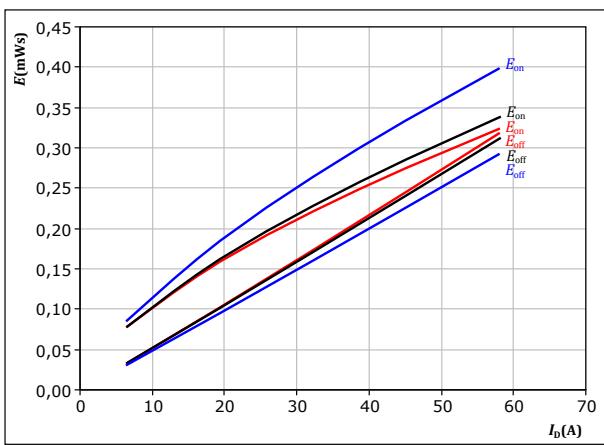
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Boost Switching Characteristics

figure 13.

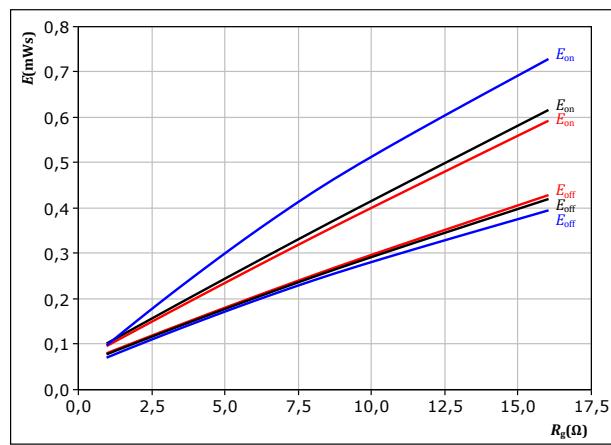
Typical switching energy losses as a function of drain current
 $E = f(I_D)$



MOSFET

figure 14.

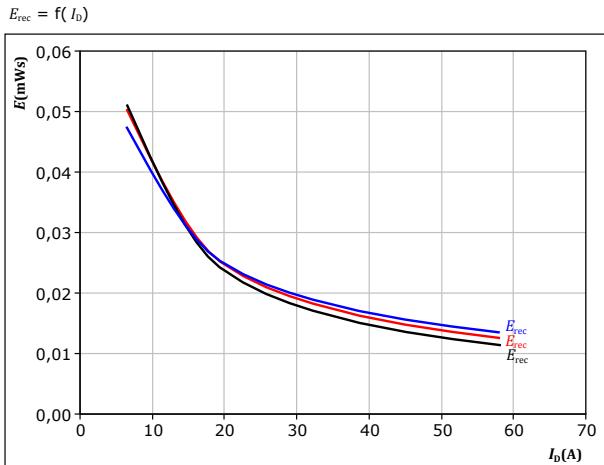
Typical switching energy losses as a function of MOSFET turn on gate resistor
 $E = f(R_g)$



MOSFET

figure 15.

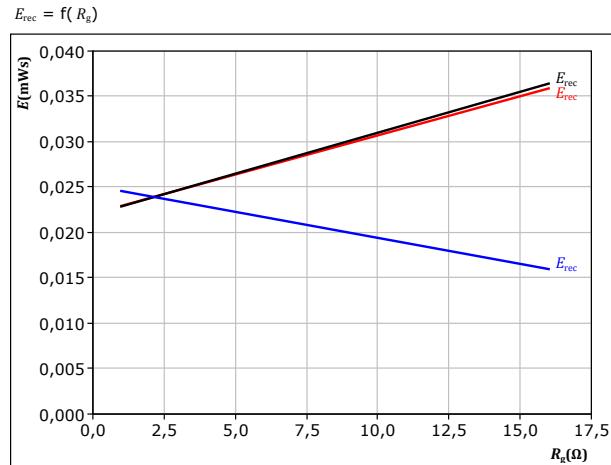
Typical reverse recovered energy loss as a function of drain current
 $E_{rec} = f(I_D)$



FWD

figure 16.

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor
 $E_{rec} = f(R_g)$



FWD



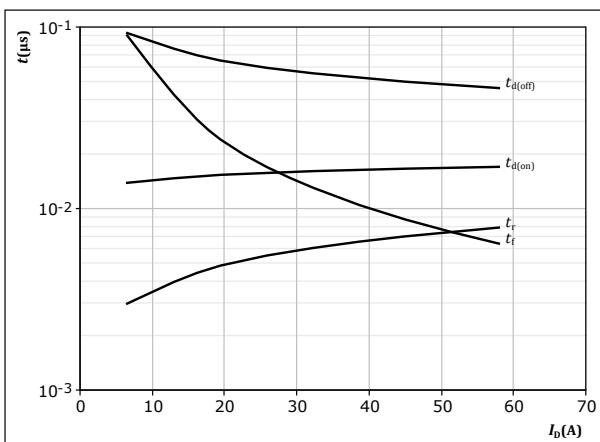
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Boost Switching Characteristics

figure 17.

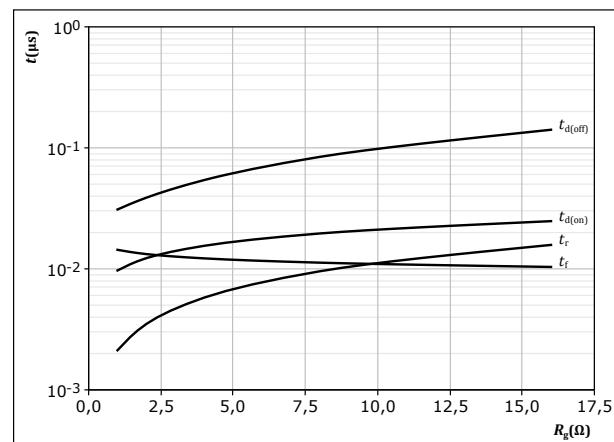
Typical switching times as a function of drain current
 $t = f(I_D)$ 

With an inductive load at

 $T_j = 150^\circ\text{C}$
 $V_{DS} = 700 \text{ V}$
 $V_{GS} = 0/15 \text{ V}$
 $R_{gon} = 4 \Omega$
 $R_{goff} = 4 \Omega$

MOSFET

figure 18.

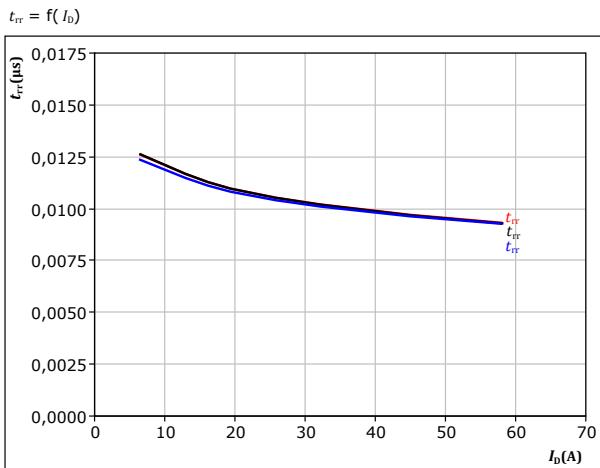
Typical switching times as a function of MOSFET turn on gate resistor
 $t = f(R_g)$ 

With an inductive load at

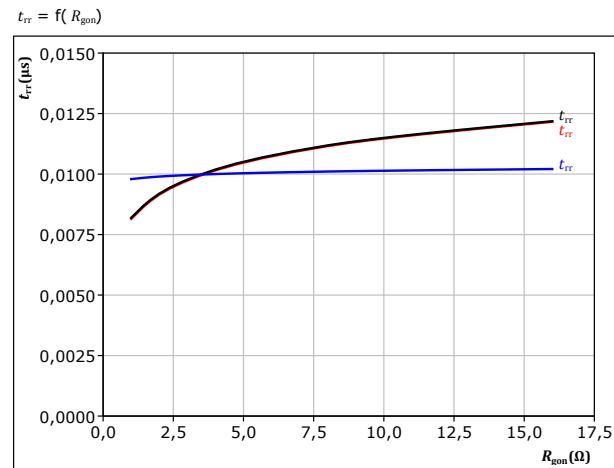
 $T_j = 150^\circ\text{C}$
 $V_{DS} = 700 \text{ V}$
 $V_{GS} = 0/15 \text{ V}$
 $I_D = 32 \text{ A}$

MOSFET

figure 19.

Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$ **At** $V_{DS} = 700 \text{ V}$
 $V_{GS} = 0/15 \text{ V}$
 $R_{gon} = 4 \Omega$ $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

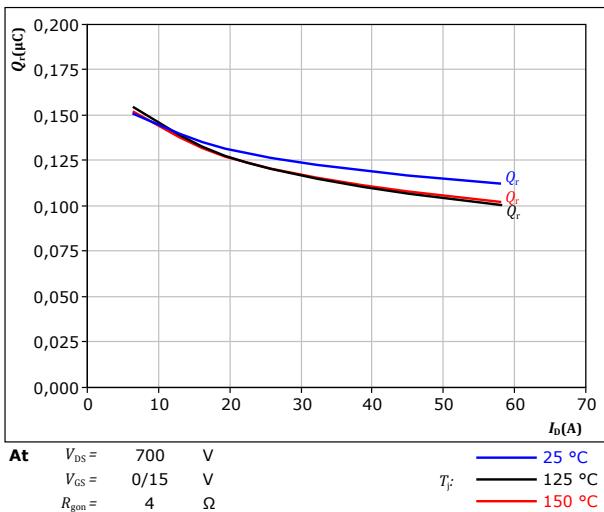
FWD

Typical reverse recovery time as a function of MOSFET turn on gate resistor
 $t_{rr} = f(R_{gon})$ **At** $V_{DS} = 700 \text{ V}$
 $V_{GS} = 0/15 \text{ V}$
 $I_D = 32 \text{ A}$ $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

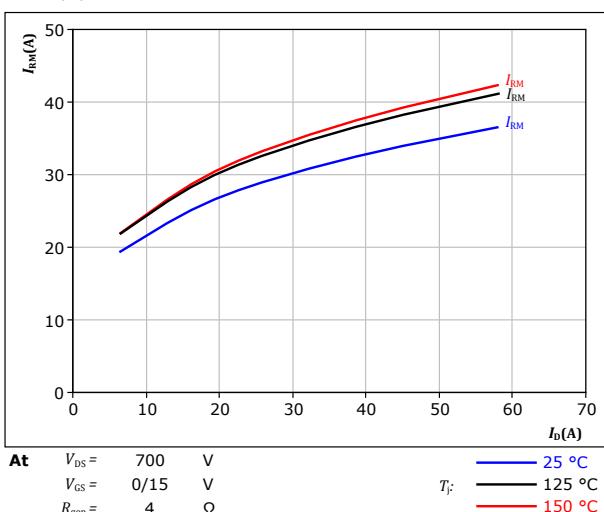
Boost Switching Characteristics

figure 21.

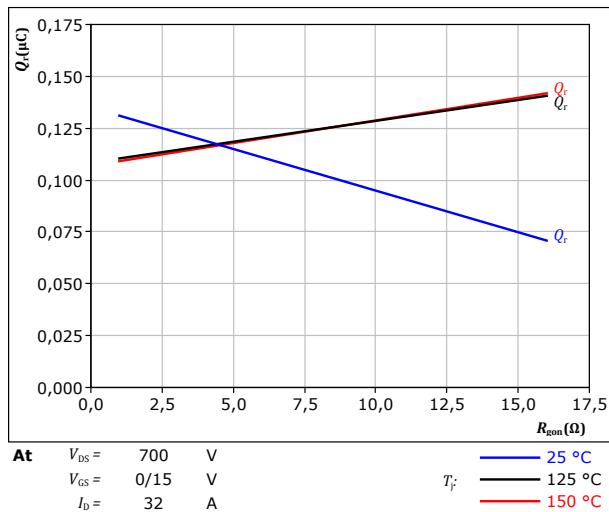
Typical recovered charge as a function of drain current
 $Q_r = f(I_D)$

**FWD****FWD****figure 23.**

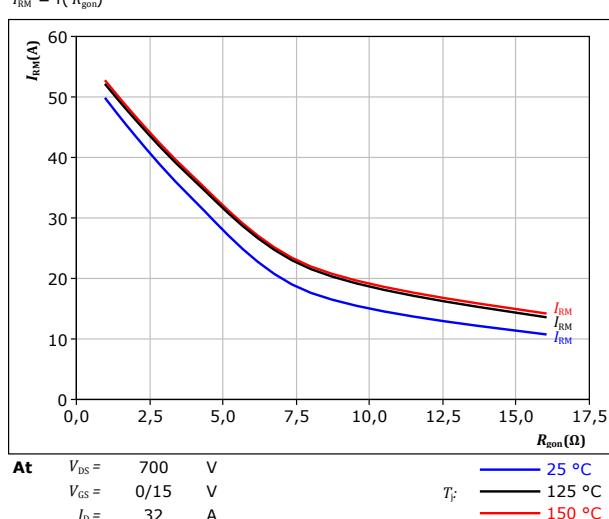
Typical peak reverse recovery current as a function of drain current
 $I_{RM} = f(I_D)$

**FWD****FWD****figure 22.**

Typical recovered charge as a function of MOSFET turn on gate resistor
 $Q_r = f(R_{gon})$

**FWD****FWD****figure 24.**

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor
 $I_{RM} = f(R_{gon})$

**FWD****FWD**



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Boost Switching Characteristics

figure 25. FWD

Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_{rr}/dt = f(I_D)$

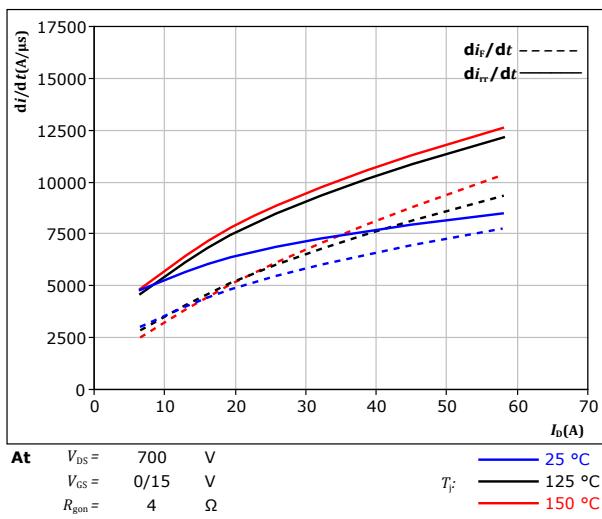


figure 26. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

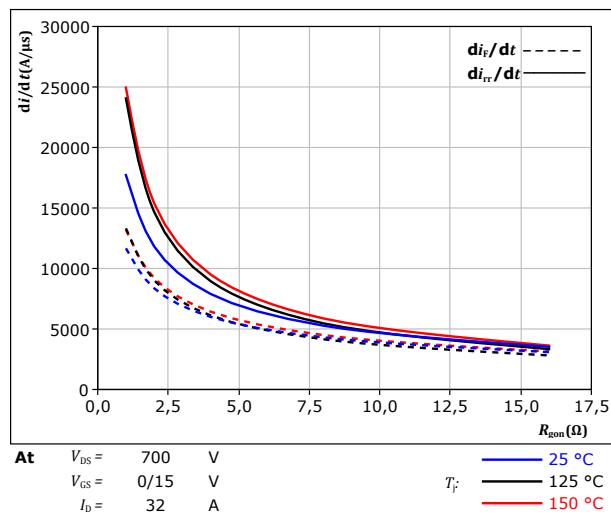
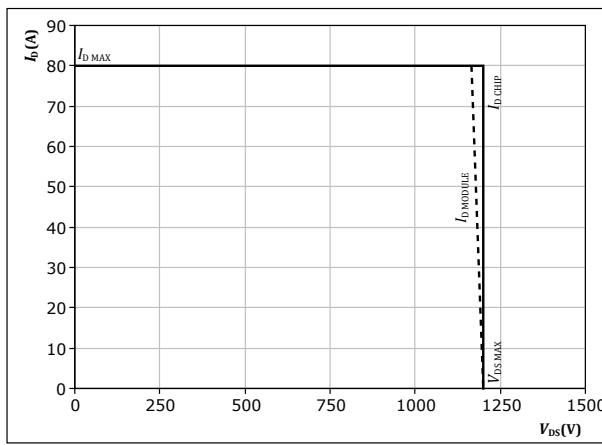


figure 27. MOSFET

Reverse bias safe operating area

$I_D = f(V_{DS})$





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Boost Switching Definitions

figure 28. MOSFET

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

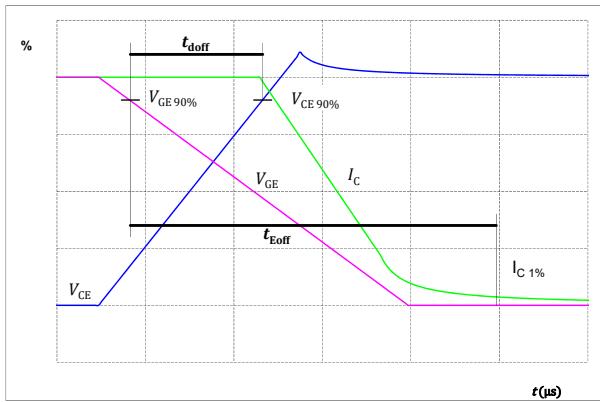


figure 30. MOSFET

Turn-off Switching Waveforms & definition of t_f

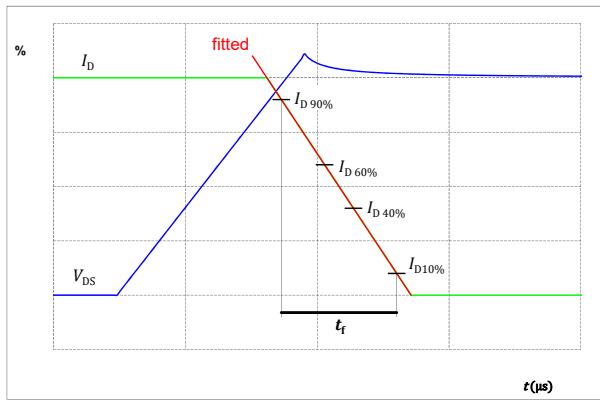


figure 29. MOSFET

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

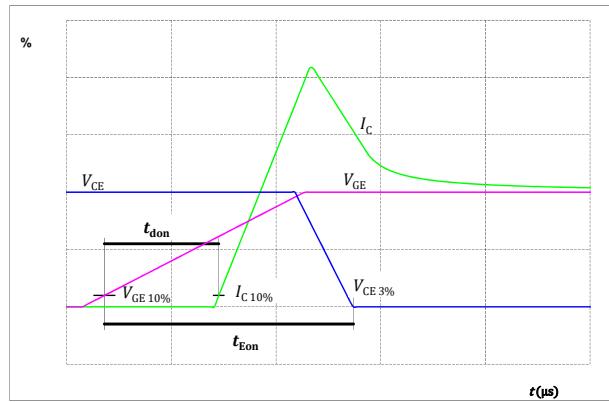
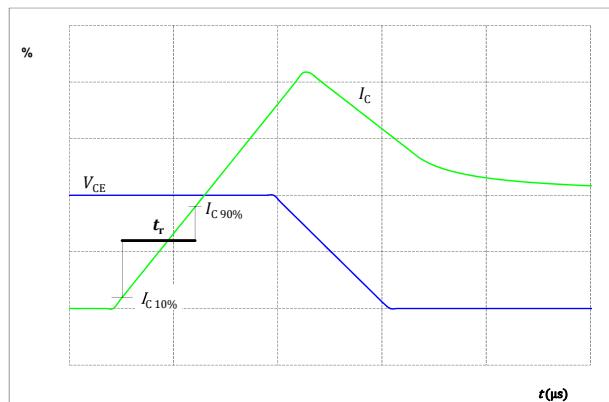


figure 31. MOSFET

Turn-on Switching Waveforms & definition of t_r





Boost Switching Definitions

figure 32.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

Turn-off Switching Waveforms & definition of t_{tr}

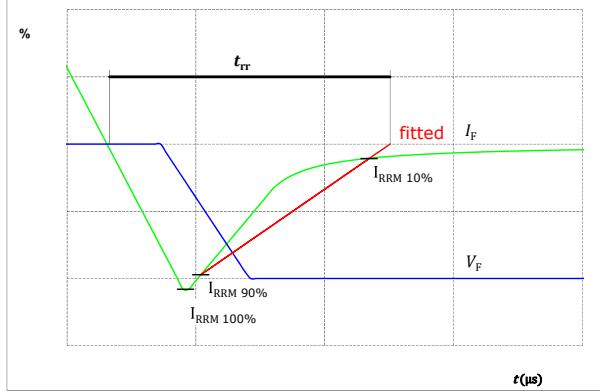


figure 33.

Turn-on Switching Waveforms & definition of t_{Qtr} (t_{Qtr} = integrating time for Q_{tr})

FWD

Turn-on Switching Waveforms & definition of t_{Qtr} (t_{Qtr} = integrating time for Q_{tr})

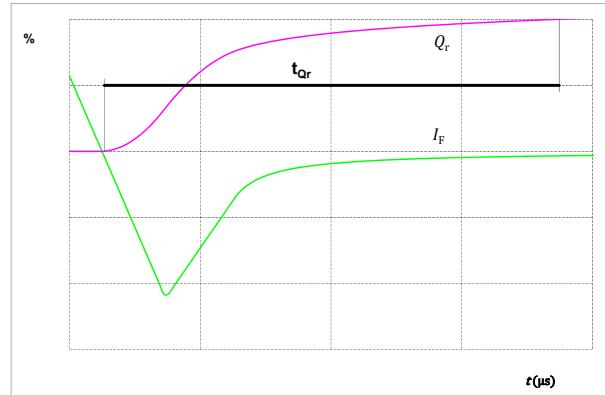
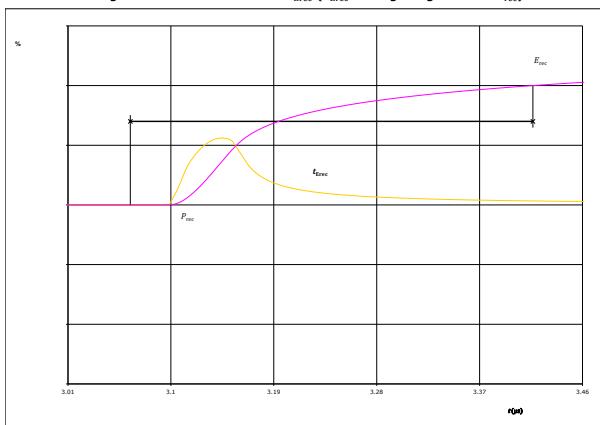


figure 34.

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})

FWD

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})





10-FY12B2A032ME-L387L28

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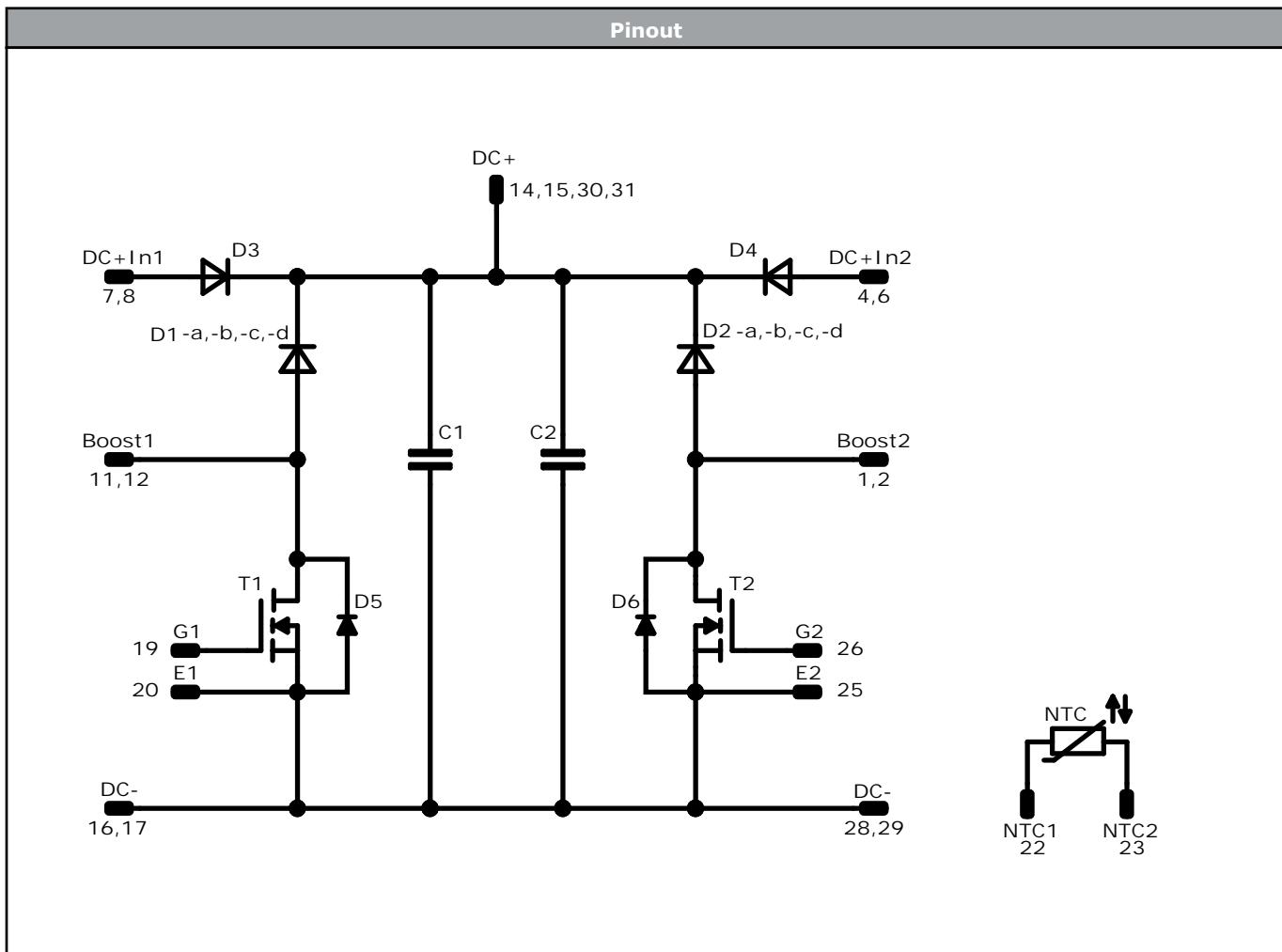
Ordering Code					
Version			Ordering Code		
Without thermal paste			10-FY12B2A032ME-L387L28		
With thermal paste (5,2 W/mK, PTM6000HV)			10-FY12B2A032ME-L387L28-/7/		
With thermal paste (3,4 W/mK, PSX-P7)			10-FY12B2A032ME-L387L28-/3/		

Marking					
Text	Name		Date code	UL & VIN	Lot
	NN-NNNNNNNNNNNNNNNNNNNN-	WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code	
	TTTTTTTVV	LLLLL	SSSS	WWYY	

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Pin table [mm]																																																																																																																																																																										
<table border="1"><thead><tr><th>Pin</th><th>X</th><th>Y</th><th>Function</th><th></th></tr></thead><tbody><tr><td>1</td><td>52,2</td><td>0</td><td>Boost2</td><td></td></tr><tr><td>2</td><td>49,2</td><td>0</td><td>Boost2</td><td></td></tr><tr><td>3</td><td colspan="3">not assembled</td><td></td></tr><tr><td>4</td><td>34,7</td><td>0</td><td>DC+In2</td><td></td></tr><tr><td>5</td><td colspan="3">not assembled</td><td></td></tr><tr><td>6</td><td>31,7</td><td>0</td><td>DC+In2</td><td></td></tr><tr><td>7</td><td>20,5</td><td>0</td><td>DC+In1</td><td></td></tr><tr><td>8</td><td>17,5</td><td>0</td><td>DC+In1</td><td></td></tr><tr><td>9</td><td colspan="3">not assembled</td><td></td></tr><tr><td>10</td><td colspan="3">not assembled</td><td></td></tr><tr><td>11</td><td>3</td><td>0</td><td>Boost1</td><td></td></tr><tr><td>12</td><td>0</td><td>0</td><td>Boost1</td><td></td></tr><tr><td>13</td><td colspan="3">not assembled</td><td></td></tr><tr><td>14</td><td>0</td><td>6</td><td>DC+</td><td></td></tr><tr><td>15</td><td>0</td><td>9</td><td>DC+</td><td></td></tr><tr><td>16</td><td>0</td><td>20,5</td><td>DC-</td><td></td></tr><tr><td>17</td><td>0</td><td>23,5</td><td>DC-</td><td></td></tr><tr><td>18</td><td colspan="3">not assembled</td><td></td></tr><tr><td>19</td><td>8,1</td><td>28,2</td><td>G1</td><td></td></tr><tr><td>20</td><td>11,1</td><td>28,2</td><td>E1</td><td></td></tr><tr><td>21</td><td colspan="3">not assembled</td><td></td></tr><tr><td>22</td><td>23,55</td><td>28,2</td><td>NTC1</td><td></td></tr><tr><td>23</td><td>28,65</td><td>28,2</td><td>NTC2</td><td></td></tr><tr><td>24</td><td colspan="3">not assembled</td><td></td></tr><tr><td>25</td><td>41,1</td><td>28,2</td><td>E2</td><td></td></tr><tr><td>26</td><td>44,1</td><td>28,2</td><td>G2</td><td></td></tr><tr><td>27</td><td colspan="3">not assembled</td><td></td></tr><tr><td>28</td><td>52,2</td><td>23,5</td><td>DC-</td><td></td></tr><tr><td>29</td><td>52,2</td><td>20,5</td><td>DC-</td><td></td></tr><tr><td>30</td><td>52,2</td><td>9</td><td>DC+</td><td></td></tr><tr><td>31</td><td>52,2</td><td>6</td><td>DC+</td><td></td></tr><tr><td>32</td><td colspan="3" rowspan="4">not assembled</td><td></td></tr></tbody></table>					Pin	X	Y	Function		1	52,2	0	Boost2		2	49,2	0	Boost2		3	not assembled				4	34,7	0	DC+In2		5	not assembled				6	31,7	0	DC+In2		7	20,5	0	DC+In1		8	17,5	0	DC+In1		9	not assembled				10	not assembled				11	3	0	Boost1		12	0	0	Boost1		13	not assembled				14	0	6	DC+		15	0	9	DC+		16	0	20,5	DC-		17	0	23,5	DC-		18	not assembled				19	8,1	28,2	G1		20	11,1	28,2	E1		21	not assembled				22	23,55	28,2	NTC1		23	28,65	28,2	NTC2		24	not assembled				25	41,1	28,2	E2		26	44,1	28,2	G2		27	not assembled				28	52,2	23,5	DC-		29	52,2	20,5	DC-		30	52,2	9	DC+		31	52,2	6	DC+		32	not assembled				
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Tolerance of pinpositions: ±0,5mm at the end of pins Dimension of coordinate axis is only offset without tolerance																																																																																																																																																																										



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Identification					
ID	Component	Voltage	Current	Function	Comment
T1, T2	MOSFET	1200 V	32 mΩ	Boost Switch	
D1, D2	FWD	1200 V	20 A	Boost Diode	
D5, D6	Rectifier	1600 V	28 A	Boost Sw. Protection Diode	
D3, D4	Rectifier	1600 V	28 A	ByPass Diode	
C1, C2	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	

**10-FY12B2A032ME-L387L28**

datasheet

Vincotech**Packaging instruction**

Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow 1 packages see vincotech.com website.

Package data

Package data for flow 1 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-FY12B2A032ME-L387L28-D1-14	1 Feb. 2022	Initial Release	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.